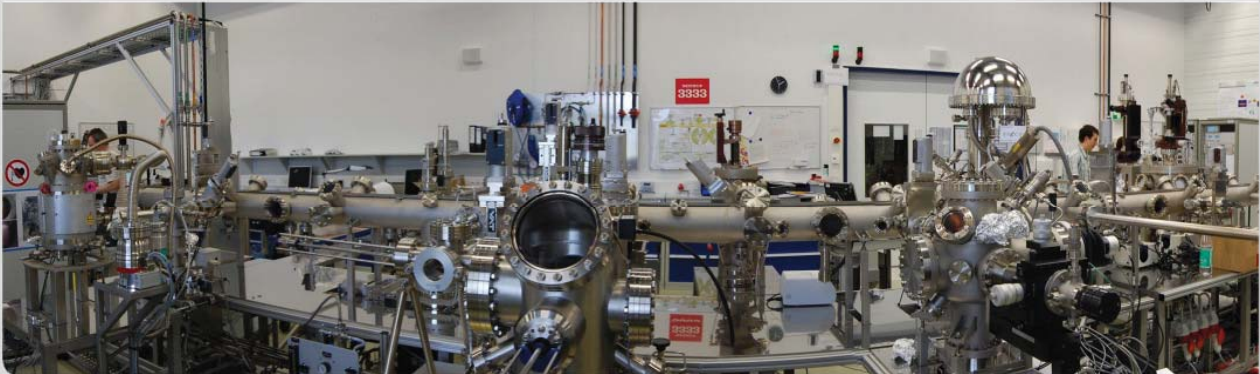


# *In situ* control of the structure formation of magnetron sputtered Vanadium Carbide coatings: periodic modulation of the microstructure

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## Motivation

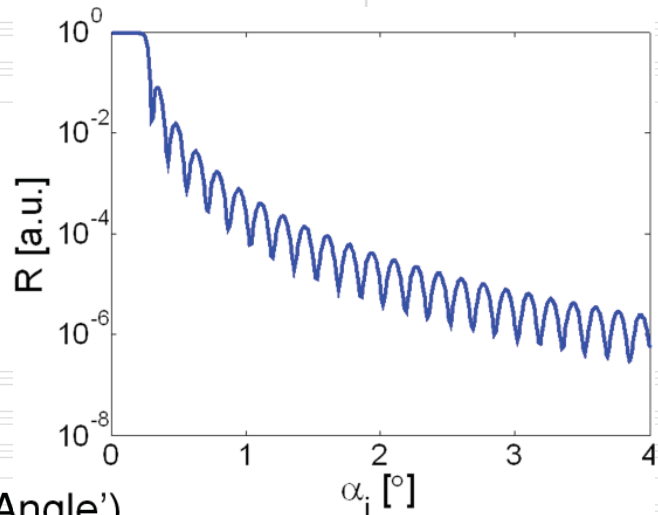
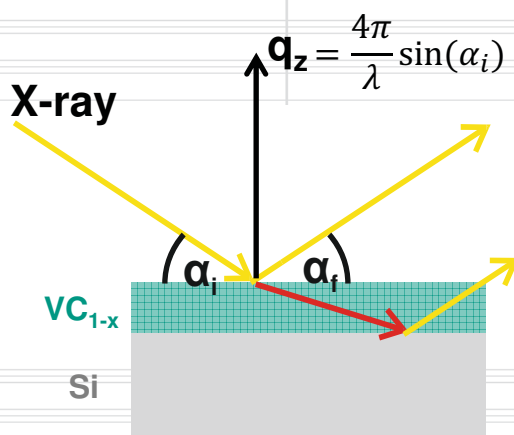
- Hard coating materials
  - Enhance life time of tools, artificial medical implants ...
- Multilayer systems
  - Tailoring of e.g. optical, tribological, mechanical properties
  - Alternating layers of **two** materials (e.g. **two** different average densities)

## New approach:

Growth conditions can influence the average density of a single layer  
**Is it possible to grow a “one-material” multilayer?**

➔ *In situ* X-ray reflectivity study during growth

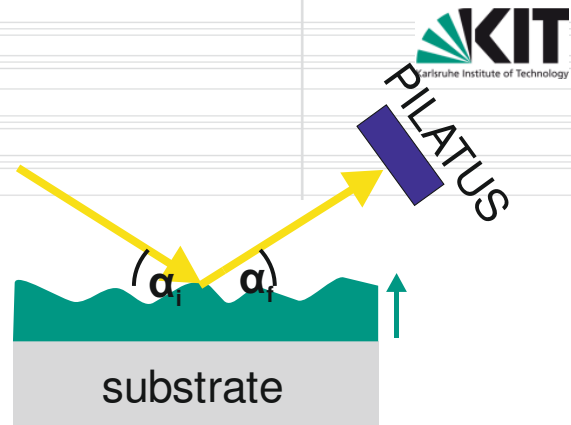
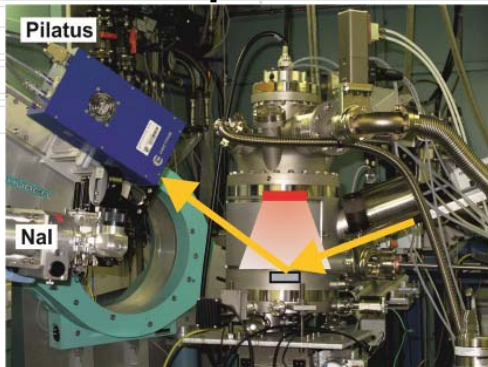
# Basics of X-Ray Reflectivity



- **Electron density** ('Critical Angle')
- **Thickness** ('Kiessig fringes'):  $D = \frac{2\pi}{\Delta q_z}$
- **Roughness** ('Slope')

[1] Pietsch, Holy, Baumbach, *High Resolution X-Ray Scattering from thin films and lateral Nanostructures*, Springer 2004

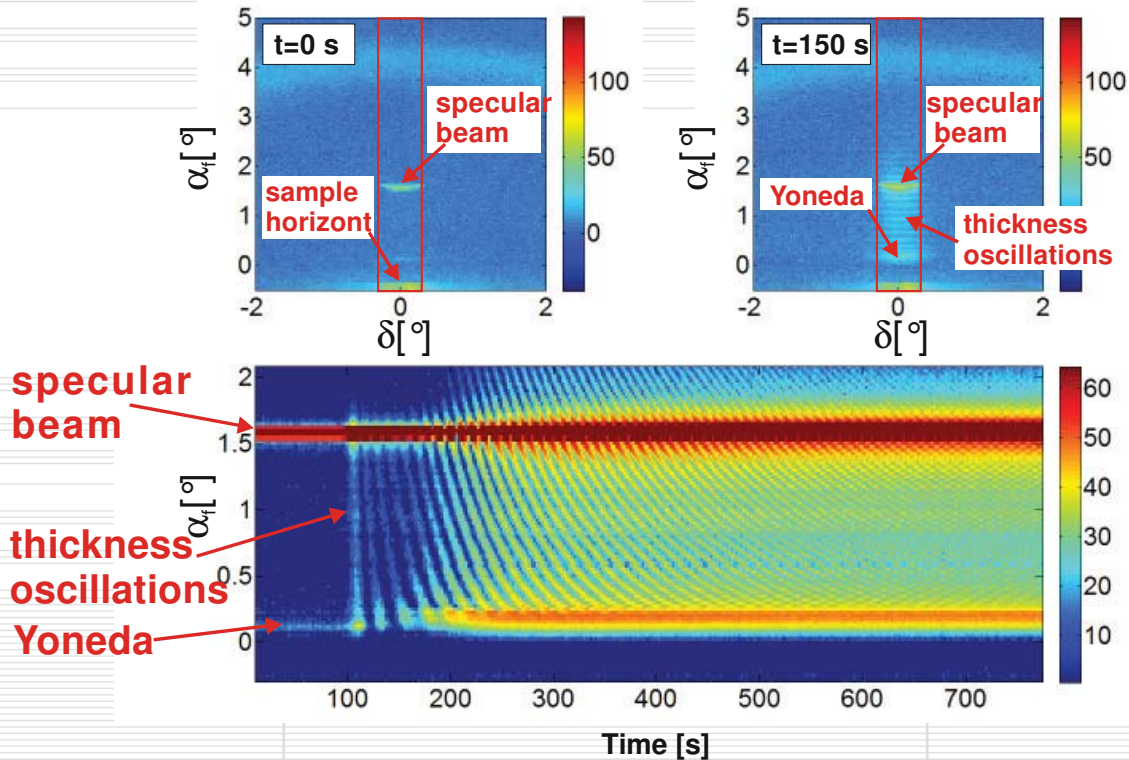
## In situ: Experimental Setup



- **Sputter conditions: [1]**
  - Target: Vanadium Carbide
  - Substrate: Si(100) with natural oxide
  - Target-substrate Distance: 10 cm
  - Argon Pressure:  $2 \times 10^{-3}$  mbar
  - Fully automatized sputtering process
  - 0.22 nm/s at DC Power 200 W
- **Setup @ MPI-Beamline:**
  - Energy: 10 keV
  - Beamsize: 300µm x 200µm
  - XRR measurements at fixed angular position:
 
$$\alpha_i = \alpha_f = 1.6^\circ$$
  - Detector: Pilatus 100K

[1] Krause et al., *J. Synchrotron Rad.* (2012), **19**, 216-222

## Pilatus measurements at $\alpha_i = \alpha_f = 1.6^\circ$



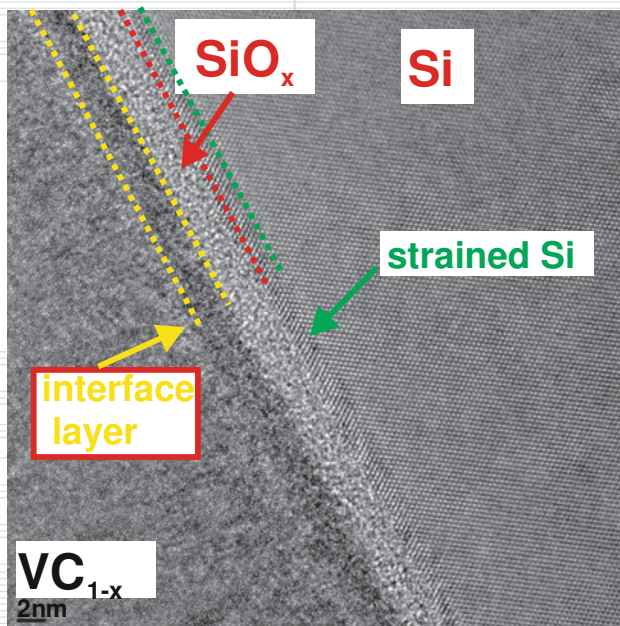
5

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*In situ* control of the structure formation: periodic modulation of the microstructure

## TEM Analysis *after growth*



- Vanadium Carbide on Silicon
- DC Power: 50 W
- Room Temperature

- Bilayer system:
  - **Growth of dense interface layer**

- *In situ* XRR measurements:
  - High pressure leads to dense growth

6

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*In situ* control of the structure formation: periodic modulation of the microstructure

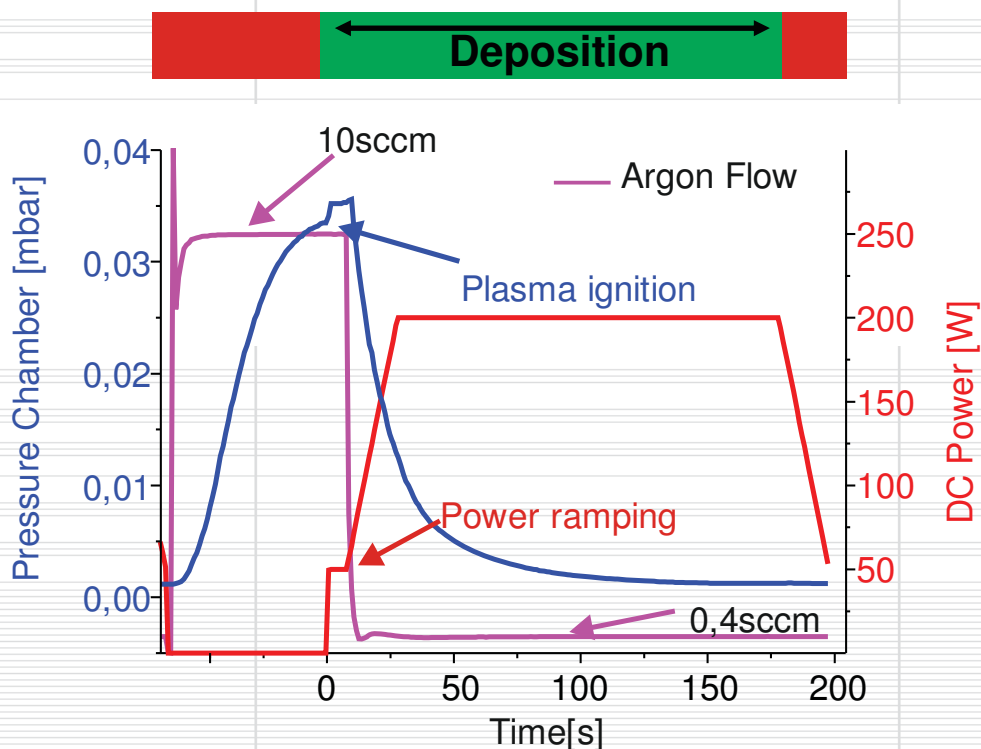
## Possibility to grow multilayer of one material!

### ■ Idea:

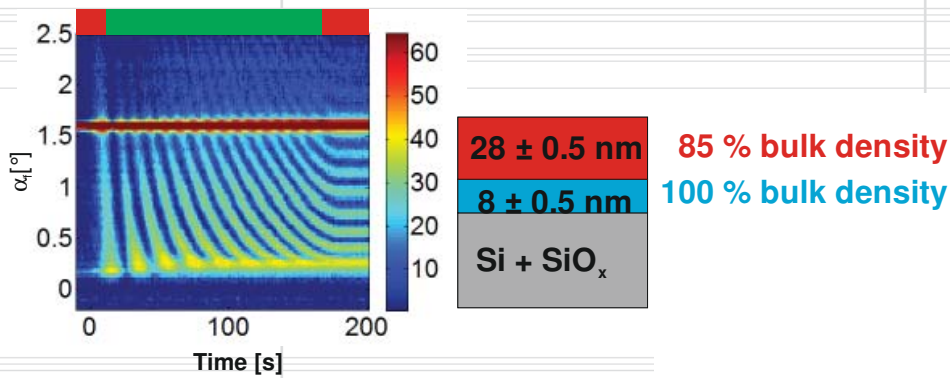
- Grow bilayer by pressure variation (high/low pressure)
- Thickness of Bilayer: 35 nm
- Deposition Time: 180s @ DC Power: 200W

➔ Repeating this process: Achieve a multilayer structure

## Multilayer by interrupted deposition: Sputtering conditions

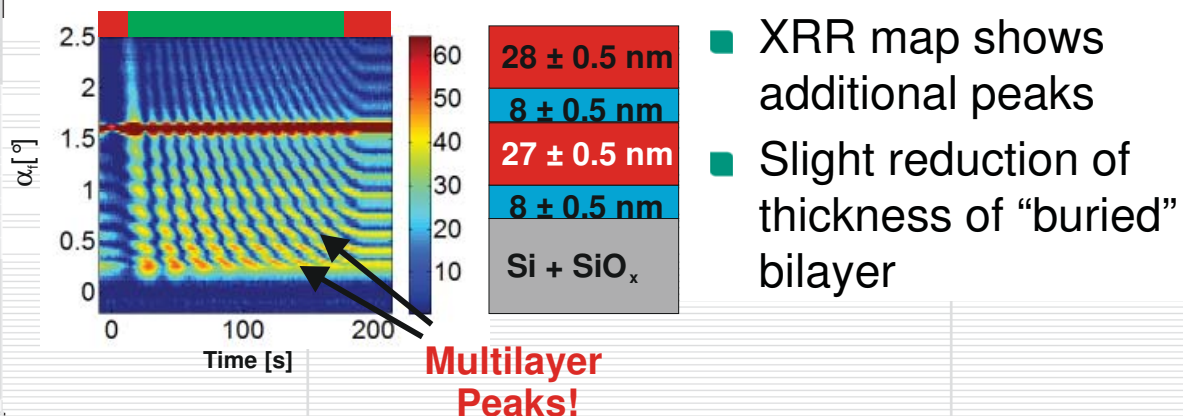
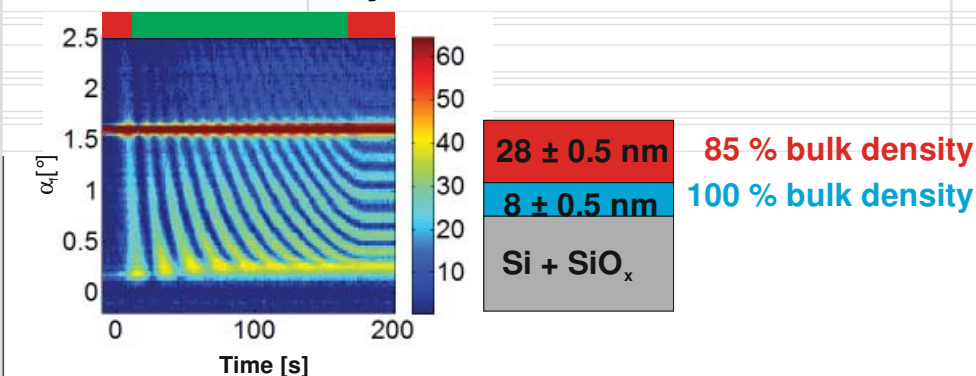


# In situ Reflectivity: Period 1

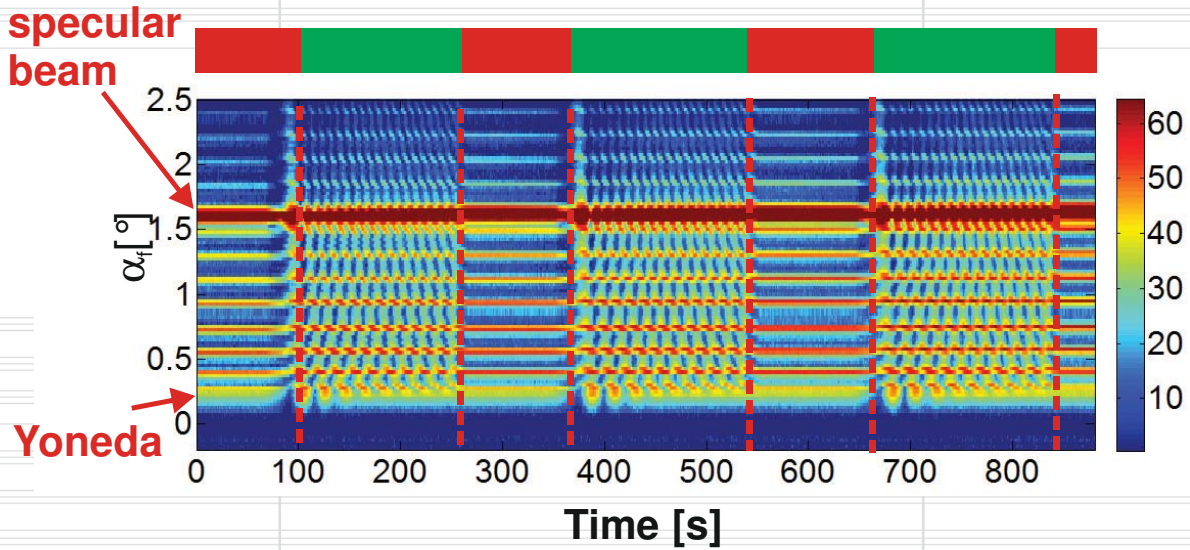


- XRR map like “normal” deposition
- Detailed Analysis: Growth of bilayer system!

# In situ Reflectivity: Period 1 and 2

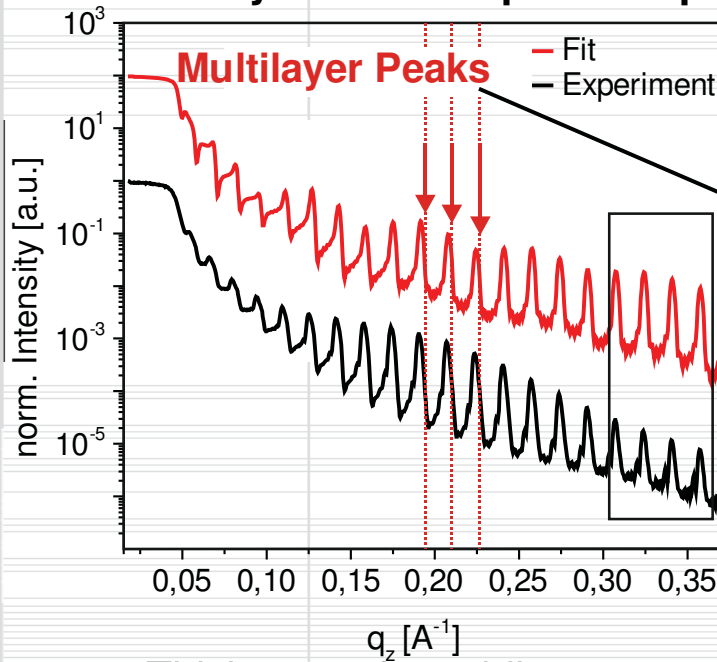


# Multilayer by interrupted deposition: *in situ* Reflectivity Periods 5-7



Growth of periodic structure!

# Multilayer by interrupted deposition: Reflectivity after 7<sup>th</sup> deposition period

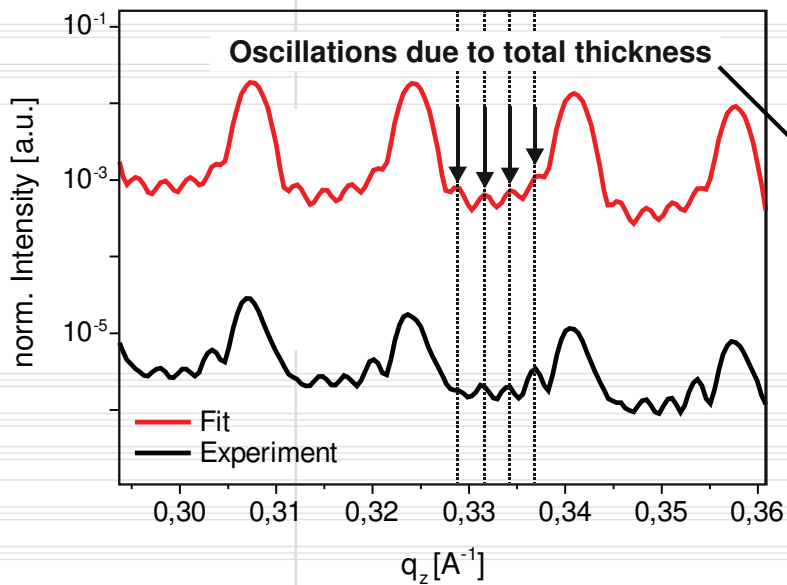


Thickness of one bilayer:  
 $35 \pm 0.75 \text{ nm}$

85 % bulk density  
100 % bulk density

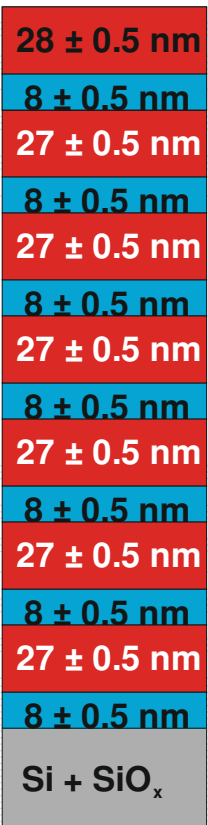
28 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
Si + SiO <sub>x</sub>

## Multilayer by interrupted deposition: Reflectivity after 7<sup>th</sup> deposition period



Total thickness  
after deposition of 7 bilayers:  
 $245 \pm 1$  nm

85 % bulk density  
100 % bulk density



## Summary

- Successful growth of multilayer systems of one material by variation of the gas pressure
  - Periodical modulation of the microstructure of single material
- Monitoring of the multilayer formation by *in situ* X-ray reflectivity measurements
  - Non-destructive investigation of the average density of the microstructure during growth
  - Sensitive to temporal changes of buried layers during deposition
- Multilayer system growth by a simple deposition process

## Acknowledgements

- H. Gräfe for technical support @ UHVLab @ ANKA
  - A. Weißhardt for „chemical“ support @ UHVChemLab @ ANKA
  - S. Darma, J. Gemmler for fruitful discussion
- 
- Financed partially in the framework of Excellence Initiative within the project KIT-Nanolab@ ANKA

Thank You for Your Attention !